

# SOT500-1

plastic leadless module carrier package; 35 mm wide tape

10 February 2016

Package information

## 1. Package summary

|                                       |   |
|---------------------------------------|---|
| <b>Terminal position code</b>         | B (bottom)                              |
| <b>Package type descriptive code</b>  | PLLMC                                   |
| <b>Package type industry code</b>     | PLLMC                                   |
| <b>Package style descriptive code</b> | PLLMC (plastic leadless module carrier) |
| <b>Package style suffix code</b>      | NA (not applicable)                     |
| <b>Package body material type</b>     | P (plastic)                             |
| <b>Mounting method type</b>           | S (surface mount)                       |
| <b>Issue date</b>                     | 16-1-2013                               |

Table 1. Package summary

| Symbol         | Parameter                      | Min   | Typ | Nom  | Max   | Unit |
|----------------|--------------------------------|-------|-----|------|-------|------|
| D              | package length                 | [tbd] | -   | 35   | [tbd] | mm   |
| A              | seated height                  | [tbd] | -   | 0.25 | 0.25  | mm   |
| n <sub>2</sub> | actual quantity of termination | -     | -   | 0    | -     |      |



## 2. Legal information

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